Electronic Paten	it App	lication Fee	Transm	ittal			
Application Number:	105	10533237					
Filing Date:	29-	29-Apr-2005					
Title of Invention:	МЕ	METHOD OF IMMOBILIZING COMPOUND ON SOLID PHASE SUPPORT					
First Named Inventor/Applicant Name:	Aki	Akito Tanaka					
Filer:	Ma	Marvin Jay Spivak/Mimi Chanthaphone					
Attorney Docket Number:	271	271731US0PCT					
Filed as Large Entity							
U.S. National Stage under 35 USC 371 Filir	ng Fee	5					
Description		Fee Code	Quantity	Amount	Sub-Total ir USD(\$)		
Basic Filing:					1		
Pages:							
Claims:							
Miscellaneous-Filing:							
Petition:							
Patent-Appeals-and-Interference:							
Post-Allowance-and-Post-Issuance:							

Publ. Fee- early, voluntary, or normal

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Extension-of-Time:				
Miscellaneous:				
	Total in USD (\$)			1810